C2000 LaunchPadXL TMS320F28069M adapter for TIDA-01527

Symbol mirrored to match the bottom TIDA-01527 view

Symbol mirrored to match the top view
PCB Number: TIDA-01527
PCB Rev: E1

Assembly Note
This Assembly Note is for PCB labels only.

Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Pb-Free Symbol

FCC disclaimer
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